Au

IBM Docket No. FIS920040002US1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Mukta G. Farooq et al.

Serial No.:

10/711,501

Date:

February 9, 2006

Filed:

September 22, 2004

Group Art Unit:

1725

Title:

SOLDER INTERCONNECTION ARRAY WITH OPTIMAL

MECHANICAL INTEGRITY

DeLIO & PETERSON, LLC 121 Whitney Avenue New Haven, CT 06510-1241

LETTER TO OFFICIAL DRAFTSMAN

Mail Stop <u>PGPUB Drawings</u> Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Applicants are herewith submitting 9 sheets of Formal Drawings for the approval of the Draftsman.

Please charge the Assignee IBM Corporation Deposit Account No. **09-0458** for any fee related to the acceptance of the attached Formal Drawings. A duplicate copy of this letter is enclosed for that purpose.

CERTIFICATE OF MAILING UN	DER 37 CFR 1.8
I hereby certify that I am depositing the correspondence with the United States F mail in an envelope addressed to Mail S Commissioner for Patents, P.O. Box 145 1450.	Postal Service as first class top PGPUB Drawings,
onFebruary 9, 2006	
garol M. Thomas	
Name of person mailing paper Augustus	02/09/06
Signature	Date

Respectfully submitted,

BY:

Attorney: Kelly M. Nowak Registration No. 47,898

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